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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	384
Number of Logic Elements/Cells	-
Total RAM Bits	442368
Number of I/O	172
Number of Gates	250000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v250-5fgg256i

Table 6: Virtex-II Device/Package Combinations and Maximum Number of Available I/Os (Advance Information)

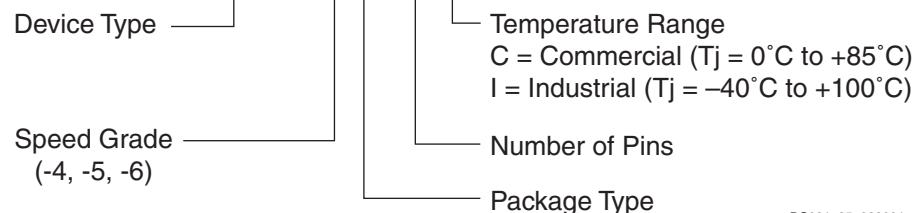
Package ^(1,2)	Available I/Os										
	XC2V 40	XC2V 80	XC2V 250	XC2V 500	XC2V 1000	XC2V 1500	XC2V 2000	XC2V 3000	XC2V 4000	XC2V 6000	XC2V 8000
CS144/CSG144	88	92	92	-	-	-	-	-	-	-	-
FG256/FGG256	88	120	172	172	172	-	-	-	-	-	-
FG456/FGG456	-	-	200	264	324	-	-	-	-	-	-
FG676/FGG676	-	-	-	-	-	392	456	484	-	-	-
FF896	-	-	-	-	432	528	624	-	-	-	-
FF1152	-	-	-	-	-	-	-	720	824	824	824
FF1517	-	-	-	-	-	-	-	-	912	1,104	1,108
BG575/BGG575	-	-	-	-	328	392	408	-	-	-	-
BG728/BGG728	-	-	-	-	-	-	-	516	-	-	-
BF957	-	-	-	-	-	-	624	684	684	684	-

Notes:

1. All devices in a particular package are pinout (footprint) compatible. In addition, the FG456/FGG456 and FG676/FGG676 packages are compatible, as are the FF896 and FF1152 packages.
2. Wire-bond packages CS144, FG256, FG456, FG676, BG575, and BG728 are also available in Pb-free versions CSG144, FGG256, FGG456, FGG676, BGG575, and BGG728. See [Virtex-II Ordering Examples](#) for details on how to order.

Virtex-II Ordering Examples

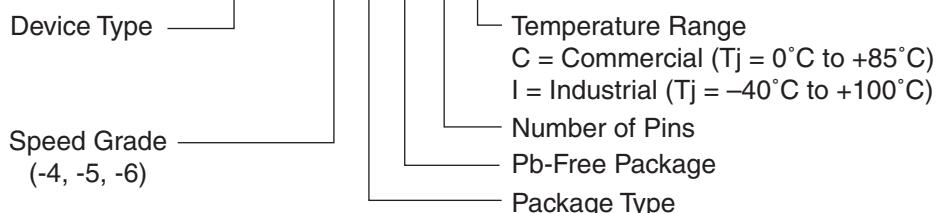
Example: XC2V1000-5FG456C



DS031_35_033001

Figure 2: Virtex-II Ordering Example. Regular Package

Example: XC2V3000-6BGG728C



DS031_35a_061804

Figure 3: Virtex-II Ordering Example. Pb-Free Package

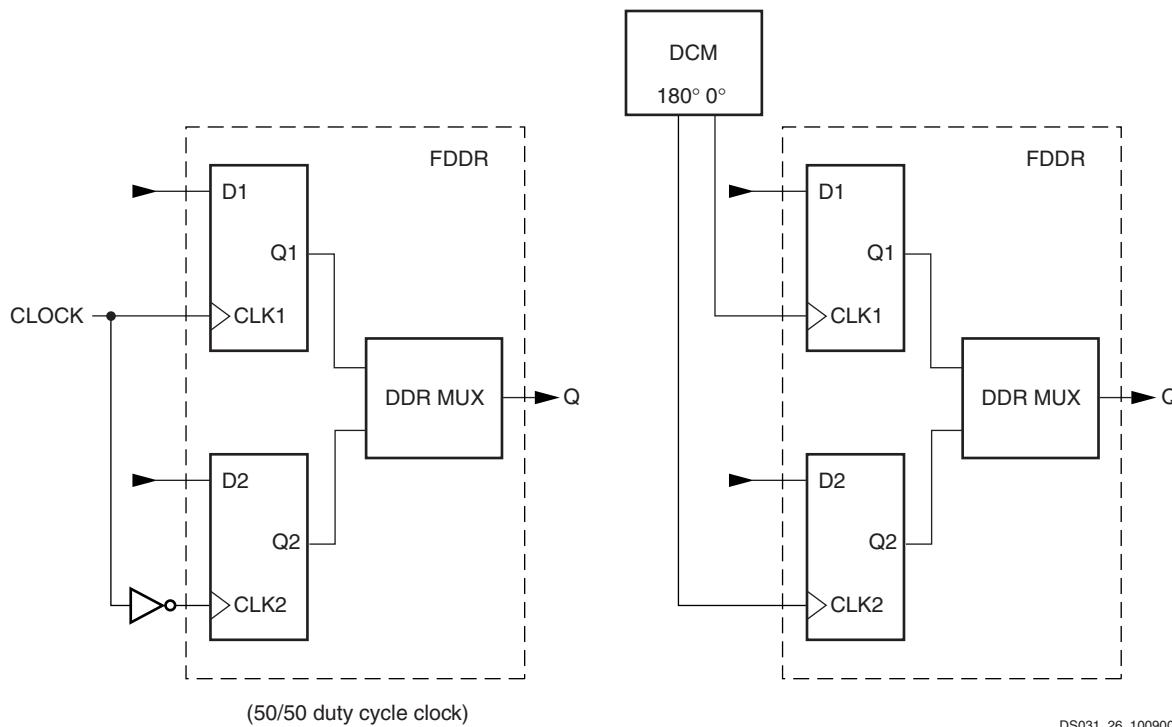


Figure 3: Double Data Rate Registers

The DDR mechanism shown in [Figure 3](#) can be used to mirror a copy of the clock on the output. This is useful for propagating a clock along the data that has an identical delay. It is also useful for multiple clock generation, where there is a unique clock driver for every clock load. Virtex-II devices can produce many copies of a clock with very little skew.

Each group of two registers has a clock enable signal (ICE for the input registers, OCE for the output registers, and TCE for the 3-state registers). The clock enable signals are active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

Each IOB block has common synchronous or asynchronous set and reset (SR and REV signals).

SR forces the storage element into the state specified by the SRHIGH or SRLOW attribute. SRHIGH forces a logic “1”. SRLOW forces a logic “0”. When SR is used, a second input (REV) forces the storage element into the opposite state. The reset condition predominates over the set condition. The initial state after configuration or global initialization state is defined by a separate INIT0 and INIT1 attribute. By default, the SRLOW attribute forces INIT0, and the SRHIGH attribute forces INIT1.

For each storage element, the SRHIGH, SRLOW, INIT0, and INIT1 attributes are independent. Synchronous or asynchronous set / reset is consistent in an IOB block.

All the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

Each register or latch (independent of all other registers or latches) (see [Figure 4](#)) can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset overrides a set, and an asynchronous clear overrides a preset.

Multiplexers

Virtex-II function generators and associated multiplexers can implement the following:

- 4:1 multiplexer in one slice
- 8:1 multiplexer in two slices
- 16:1 multiplexer in one CLB element (4 slices)
- 32:1 multiplexer in two CLB elements (8 slices)

Each Virtex-II slice has one MUXF5 multiplexer and one MUXFX multiplexer. The MUXFX multiplexer implements the MUXF6, MUXF7, or MUXF8, as shown in [Figure 23](#). Each CLB element has two MUXF6 multiplexers, one MUXF7 multiplexer and one MUXF8 multiplexer. Examples of multiplexers are shown in the *Virtex-II Platform FPGA User Guide*. Any LUT can implement a 2:1 multiplexer.

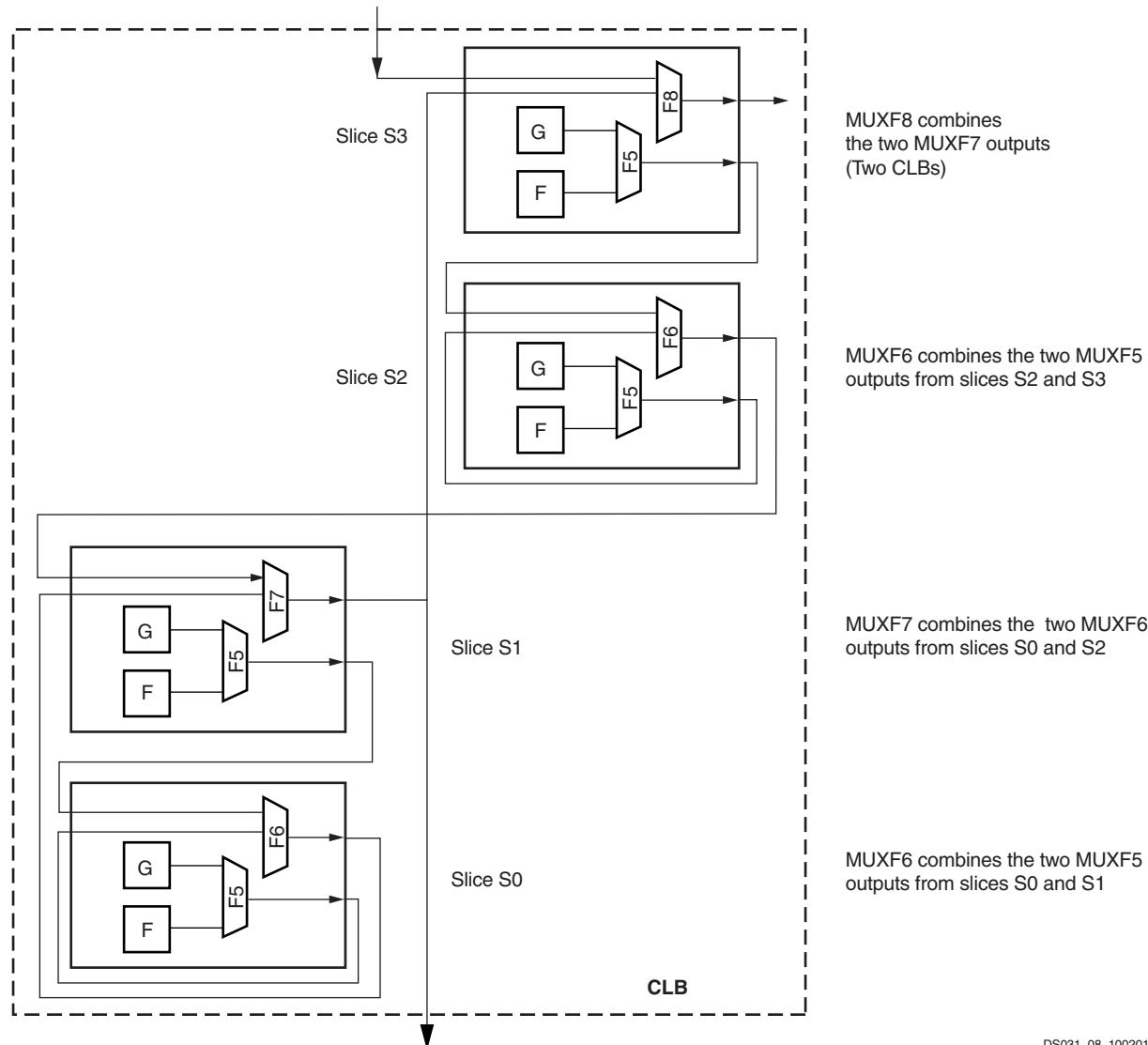


Figure 23: MUXF5 and MUXFX multiplexers

DS031_08_100201

Fast Lookahead Carry Logic

Dedicated carry logic provides fast arithmetic addition and subtraction. The Virtex-II CLB has two separate carry chains, as shown in the [Figure 24](#).

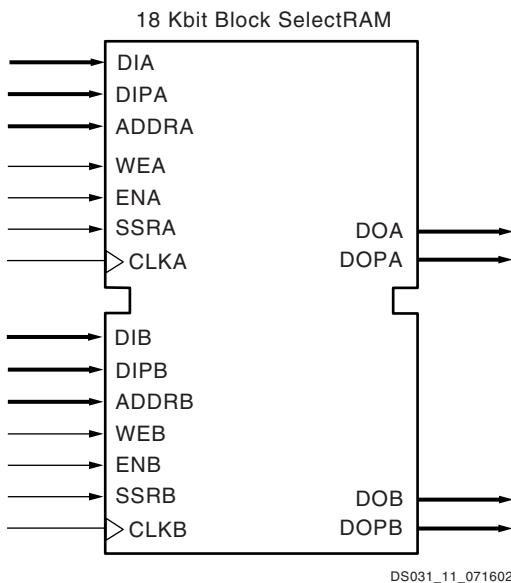
The height of the carry chains is two bits per slice. The carry chain in the Virtex-II device is running upward. The dedicated carry path and carry multiplexer (MUXCY) can also

be used to cascade function generators for implementing wide logic functions.

Arithmetic Logic

The arithmetic logic includes an XOR gate that allows a 2-bit full adder to be implemented within a slice. In addition, a dedicated AND (MULT_AND) gate (shown in [Figure 16](#)) improves the efficiency of multiplier implementation.

Each block SelectRAM cell is a fully synchronous memory, as illustrated in [Figure 30](#). The two ports have independent inputs and outputs and are independently clocked.



[Figure 30: 18 Kbit Block SelectRAM in Dual-Port Mode](#)

Port Aspect Ratios

[Table 16](#) shows the depth and the width aspect ratios for the 18 Kbit block SelectRAM. Virtex-II block SelectRAM also includes dedicated routing resources to provide an efficient interface with CLBs, block SelectRAM, and multipliers.

[Table 16: 18 Kbit Block SelectRAM Port Aspect Ratio](#)

Width	Depth	Address Bus	Data Bus	Parity Bus
1	16,384	ADDR[13:0]	DATA[0]	N/A
2	8,192	ADDR[12:0]	DATA[1:0]	N/A
4	4,096	ADDR[11:0]	DATA[3:0]	N/A
9	2,048	ADDR[10:0]	DATA[7:0]	Parity[0]
18	1,024	ADDR[9:0]	DATA[15:0]	Parity[1:0]
36	512	ADDR[8:0]	DATA[31:0]	Parity[3:0]

Read/Write Operations

The Virtex-II block SelectRAM read operation is fully synchronous. An address is presented, and the read operation is enabled by control signals WEA and WEB in addition to ENA or ENB. Then, depending on clock polarity, a rising or falling clock edge causes the stored data to be loaded into output registers.

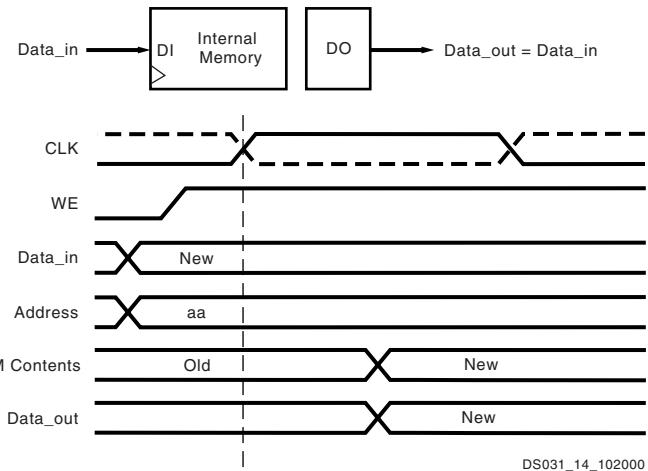
The write operation is also fully synchronous. Data and address are presented, and the write operation is enabled by control signals WEA or WEB in addition to ENA or ENB. Then, again depending on the clock input mode, a rising or

falling clock edge causes the data to be loaded into the memory cell addressed.

A write operation performs a simultaneous read operation. Three different options are available, selected by configuration:

1. “WRITE_FIRST”

The “WRITE_FIRST” option is a transparent mode. The same clock edge that writes the data input (DI) into the memory also transfers DI into the output registers DO as shown in [Figure 31](#).

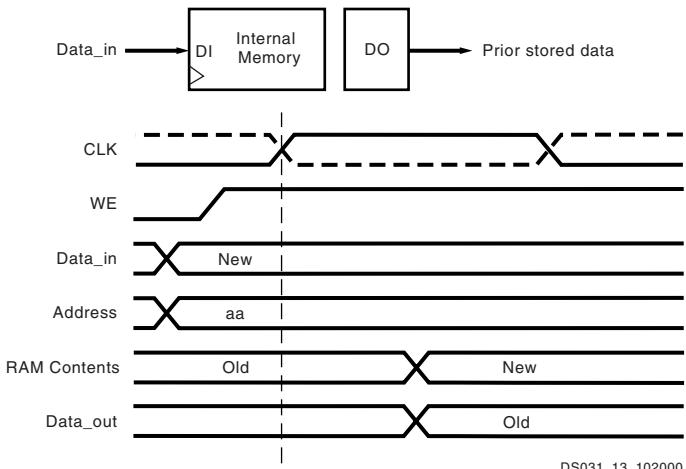


[Figure 31: WRITE_FIRST Mode](#)

2. “READ_FIRST”

The “READ_FIRST” option is a read-before-write mode.

The same clock edge that writes data input (DI) into the memory also transfers the prior content of the memory cell addressed into the data output registers DO, as shown in [Figure 32](#).



[Figure 32: READ_FIRST Mode](#)

3. “NO_CHANGE”

The “NO_CHANGE” option maintains the content of the output registers, regardless of the write operation. The clock edge during the write mode has no effect on the content of the data output register DO. When the port is configured as “NO_CHANGE”, only a read operation loads a new value in the output register DO, as shown in Figure 33.

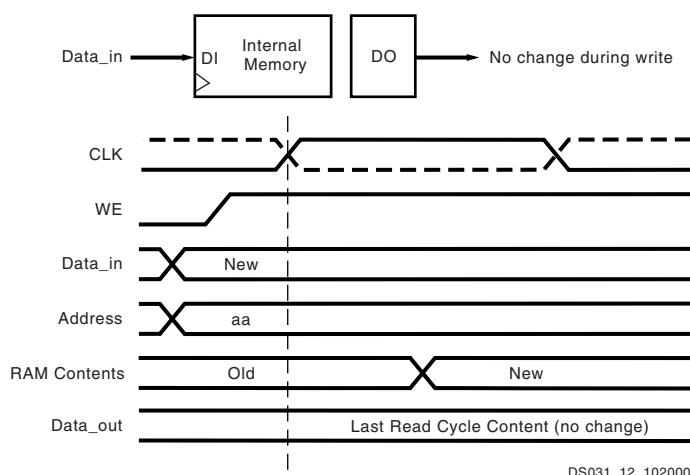


Figure 33: NO_CHANGE Mode

Control Pins and Attributes

Virtex-II SelectRAM memory has two independent ports with the control signals described in Table 17. All control inputs including the clock have an optional inversion.

Table 17: Control Functions

Control Signal	Function
CLK	Read and Write Clock
EN	Enable affects Read, Write, Set, Reset
WE	Write Enable
SSR	Set DO register to SRVAL (attribute)

Initial memory content is determined by the INIT_xx attributes. Separate attributes determine the output register value after device configuration (INIT) and SSR is asserted (SRVAL). Both attributes (INIT_B and SRVAL) are available for each port when a block SelectRAM resource is configured as dual-port RAM.

Locations

Virtex-II SelectRAM memory blocks are located in either four or six columns. The number of blocks per column depends of the device array size and is equivalent to the number of CLBs in a column divided by four. Column locations are shown in Table 18.

Table 18: SelectRAM Memory Floor Plan

Device	Columns	SelectRAM Blocks	
		Per Column	Total
XC2V40	2	2	4
XC2V80	2	4	8
XC2V250	4	6	24
XC2V500	4	8	32
XC2V1000	4	10	40
XC2V1500	4	12	48
XC2V2000	4	14	56
XC2V3000	6	16	96
XC2V4000	6	20	120
XC2V6000	6	24	144
XC2V8000	6	28	168

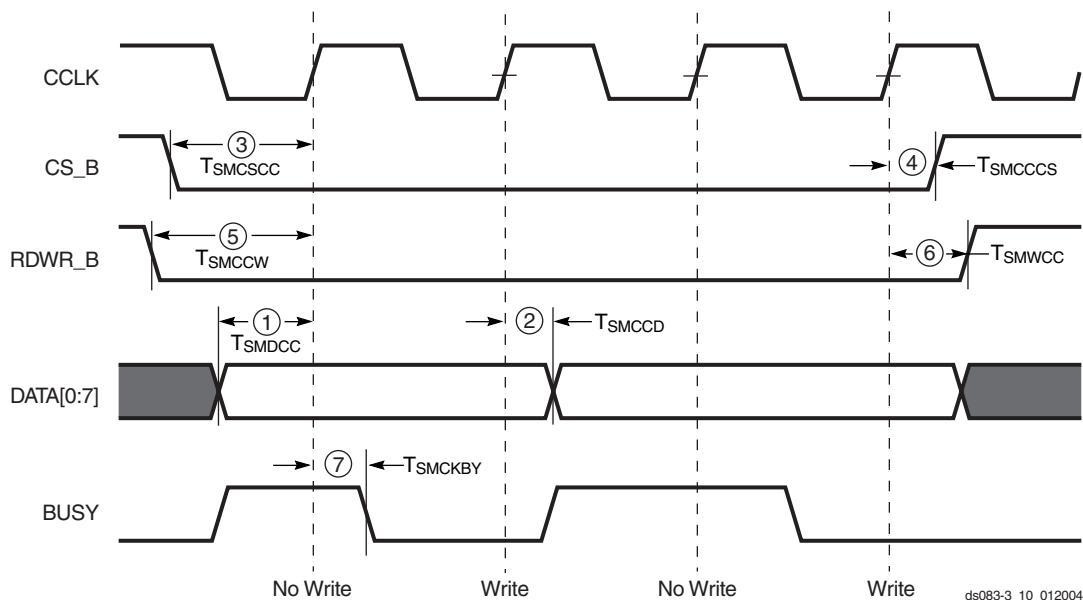


Figure 5: SelectMAP Mode Data Loading Sequence (Generic)

Table 32: SelectMAP Mode Write Timing Characteristics

	Description	Figure References	Symbol	Value	Units
CCLK	DATA[0:7] setup/hold	1/2	T_{SMDCC}/T_{SMCCD}	5.0/0.0	ns, min
	CS_B setup/hold	3/4	T_{SMSCCC}/T_{SMCCCS}	7.0/0.0	ns, min
	RDWR_B setup/hold	5/6	T_{SMCCW}/T_{SMWCC}	7.0/0.0	ns, min
	BUSY propagation delay	7	T_{SMCKBY}	12.0	ns, max
	Maximum start-up frequency		$F_{CC_STARTUP}$	50	MHz, max
	Maximum frequency		$F_{CC_SELECTMAP}$	50	MHz, max
	Maximum frequency with no handshake		F_{CCNH}	50	MHz, max

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
5	IO_L06P_5	W6		
5	IO_L05N_5/VRP_5	V7		
5	IO_L05P_5/VRN_5	V6		
5	IO_L04N_5	AB5		
5	IO_L04P_5/VREF_5	AA5		
5	IO_L03N_5/D4/ALT_VRP_5	Y5		
5	IO_L03P_5/D5/ALT_VRN_5	W5		
5	IO_L02N_5/D6	AB4		
5	IO_L02P_5/D7	AA4		
5	IO_L01N_5/RDWR_B	Y4		
5	IO_L01P_5/CS_B	AA3		
6	IO_L01P_6	V5		
6	IO_L01N_6	U5		
6	IO_L02P_6/VRN_6	Y2		
6	IO_L02N_6/VRP_6	Y1		
6	IO_L03P_6	V4		
6	IO_L03N_6/VREF_6	V3		
6	IO_L04P_6	W2		
6	IO_L04N_6	W1		
6	IO_L06P_6	U4		
6	IO_L06N_6	U3		
6	IO_L19P_6	V2	NC	NC
6	IO_L19N_6	V1	NC	NC
6	IO_L21P_6	U2	NC	NC
6	IO_L21N_6/VREF_6	U1	NC	NC
6	IO_L22P_6	T5	NC	NC
6	IO_L22N_6	R5	NC	NC
6	IO_L24P_6	T4	NC	NC
6	IO_L24N_6	T3	NC	NC
6	IO_L43P_6	T2		
6	IO_L43N_6	T1		
6	IO_L45P_6	R4		
6	IO_L45N_6/VREF_6	R3		

BG728/BGG728 Standard BGA Package

As shown in [Table 10](#), XC2V3000 Virtex-II devices are available in the BG728/BGG728 BGA package. Following this table are the [BG728/BGG728 Standard BGA Package Specifications \(1.27mm pitch\)](#).

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
0	IO_L01N_0	B3
0	IO_L01P_0	A3
0	IO_L02N_0	B4
0	IO_L02P_0	A4
0	IO_L03N_0/VRP_0	C5
0	IO_L03P_0/VRN_0	C6
0	IO_L04N_0/VREF_0	B5
0	IO_L04P_0	A5
0	IO_L05N_0	E6
0	IO_L05P_0	D6
0	IO_L06N_0	B6
0	IO_L06P_0	A6
0	IO_L19N_0	E7
0	IO_L19P_0	D8
0	IO_L21N_0	F8
0	IO_L21P_0/VREF_0	E8
0	IO_L22N_0	C7
0	IO_L22P_0	C8
0	IO_L24N_0	B7
0	IO_L24P_0	A7
0	IO_L25N_0	H9
0	IO_L25P_0	J9
0	IO_L27N_0	F9
0	IO_L27P_0/VREF_0	G9
0	IO_L28N_0	E9
0	IO_L28P_0	D9
0	IO_L30N_0	C9
0	IO_L30P_0	B9
0	IO_L49N_0	A8
0	IO_L49P_0	A9
0	IO_L51N_0	G10
0	IO_L51P_0/VREF_0	H10
0	IO_L52N_0	F10

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
2	IO_L19P_2	F26
2	IO_L21N_2	F27
2	IO_L21P_2/VREF_2	G27
2	IO_L22N_2	G23
2	IO_L22P_2	H23
2	IO_L24N_2	G25
2	IO_L24P_2	G26
2	IO_L25N_2	H21
2	IO_L25P_2	J21
2	IO_L27N_2	H22
2	IO_L27P_2/VREF_2	J22
2	IO_L28N_2	H24
2	IO_L28P_2	H25
2	IO_L30N_2	H27
2	IO_L30P_2	J27
2	IO_L43N_2	J23
2	IO_L43P_2	J24
2	IO_L45N_2	J25
2	IO_L45P_2/VREF_2	J26
2	IO_L46N_2	K20
2	IO_L46P_2	K21
2	IO_L48N_2	K22
2	IO_L48P_2	K23
2	IO_L49N_2	K24
2	IO_L49P_2	K25
2	IO_L51N_2	K26
2	IO_L51P_2/VREF_2	K27
2	IO_L52N_2	L20
2	IO_L52P_2	M20
2	IO_L54N_2	L21
2	IO_L54P_2	L22
2	IO_L67N_2	L24
2	IO_L67P_2	L25
2	IO_L69N_2	L26
2	IO_L69P_2/VREF_2	L27
2	IO_L70N_2	M19

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
3	IO_L72N_3	T20
3	IO_L72P_3	T19
3	IO_L70N_3	U27
3	IO_L70P_3	U26
3	IO_L69N_3/VREF_3	U25
3	IO_L69P_3	V25
3	IO_L67N_3	U21
3	IO_L67P_3	U20
3	IO_L54N_3	V27
3	IO_L54P_3	V26
3	IO_L52N_3	V24
3	IO_L52P_3	V23
3	IO_L51N_3/VREF_3	V22
3	IO_L51P_3	W22
3	IO_L49N_3	V21
3	IO_L49P_3	V20
3	IO_L48N_3	W27
3	IO_L48P_3	Y27
3	IO_L46N_3	W26
3	IO_L46P_3	W25
3	IO_L45N_3/VREF_3	W24
3	IO_L45P_3	W23
3	IO_L43N_3	W21
3	IO_L43P_3	W20
3	IO_L28N_3	W19
3	IO_L28P_3	Y19
3	IO_L27N_3/VREF_3	Y25
3	IO_L27P_3	Y24
3	IO_L25N_3	Y23
3	IO_L25P_3	AA23
3	IO_L24N_3	Y22
3	IO_L24P_3	Y21
3	IO_L22N_3	AA27
3	IO_L22P_3	AB27
3	IO_L21N_3/VREF_3	AA26
3	IO_L21P_3	AA25

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
6	IO_L20P_6	AE26		
6	IO_L20N_6	AD26		
6	IO_L21P_6	AG30		
6	IO_L21N_6/VREF_6	AF30		
6	IO_L22P_6	AD25		
6	IO_L22N_6	AC25		
6	IO_L23P_6	AE28		
6	IO_L23N_6	AD28		
6	IO_L24P_6	AD29		
6	IO_L24N_6	AE29		
6	IO_L43P_6	AC24		
6	IO_L43N_6	AB24		
6	IO_L44P_6	AD27		
6	IO_L44N_6	AC27		
6	IO_L45P_6	AC26		
6	IO_L45N_6/VREF_6	AB26		
6	IO_L46P_6	AA23		
6	IO_L46N_6	Y23		
6	IO_L47P_6	AC28		
6	IO_L47N_6	AB28		
6	IO_L48P_6	AD30		
6	IO_L48N_6	AE30		
6	IO_L49P_6	AB25		
6	IO_L49N_6	AA25		
6	IO_L50P_6	AA24		
6	IO_L50N_6	Y24		
6	IO_L51P_6	AC29		
6	IO_L51N_6/VREF_6	AB30		
6	IO_L52P_6	Y25		
6	IO_L52N_6	W25		
6	IO_L53P_6	AB27		
6	IO_L53N_6	AA27		
6	IO_L54P_6	AA29		
6	IO_L54N_6	AB29		
6	IO_L67P_6	W23	NC	
6	IO_L67N_6	V23	NC	
6	IO_L68P_6	AA26	NC	

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
2	VCCO_2	L10		
2	VCCO_2	L9		
2	VCCO_2	K9		
2	VCCO_2	E2		
3	VCCO_3	AF2		
3	VCCO_3	AA9		
3	VCCO_3	Y10		
3	VCCO_3	Y9		
3	VCCO_3	W10		
3	VCCO_3	W9		
3	VCCO_3	V10		
3	VCCO_3	V9		
3	VCCO_3	V3		
3	VCCO_3	U10		
3	VCCO_3	T10		
4	VCCO_4	AJ5		
4	VCCO_4	AH13		
4	VCCO_4	AB13		
4	VCCO_4	AB12		
4	VCCO_4	AB11		
4	VCCO_4	AB10		
4	VCCO_4	AA15		
4	VCCO_4	AA14		
4	VCCO_4	AA13		
4	VCCO_4	AA12		
4	VCCO_4	AA11		
5	VCCO_5	AJ26		
5	VCCO_5	AH18		
5	VCCO_5	AB21		
5	VCCO_5	AB20		
5	VCCO_5	AB19		
5	VCCO_5	AB18		
5	VCCO_5	AA20		
5	VCCO_5	AA19		
5	VCCO_5	AA18		
5	VCCO_5	AA17		
5	VCCO_5	AA16		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
1	IO_L22P_1	A5	
1	IO_L21N_1/VREF_1	F10	
1	IO_L21P_1	G9	
1	IO_L20N_1	J12	
1	IO_L20P_1	J11	
1	IO_L19N_1	B4	
1	IO_L19P_1	B5	
1	IO_L06N_1	D6	
1	IO_L06P_1	C6	
1	IO_L05N_1	H11	
1	IO_L05P_1	J10	
1	IO_L04N_1	D8	
1	IO_L04P_1/VREF_1	E7	
1	IO_L03N_1/VRP_1	F9	
1	IO_L03P_1/VRN_1	F8	
1	IO_L02N_1	H10	
1	IO_L02P_1	H9	
1	IO_L01N_1	C2	
1	IO_L01P_1	B3	
2	IO_L01N_2	E2	
2	IO_L01P_2	D2	
2	IO_L02N_2/VRP_2	K11	
2	IO_L02P_2/VRN_2	K10	
2	IO_L03N_2	F5	
2	IO_L03P_2/VREF_2	G5	
2	IO_L04N_2	E3	
2	IO_L04P_2	D3	
2	IO_L05N_2	J9	
2	IO_L05P_2	K9	
2	IO_L06N_2	F4	
2	IO_L06P_2	E4	
2	IO_L19N_2	E1	
2	IO_L19P_2	D1	
2	IO_L20N_2	J8	
2	IO_L20P_2	K8	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	IO_L50P_5	AG22	
5	IO_L49N_5	AN29	
5	IO_L49P_5	AN28	
5	IO_L30N_5	AK24	
5	IO_L30P_5	AK25	
5	IO_L29N_5	AH23	
5	IO_L29P_5	AH22	
5	IO_L28N_5	AP31	
5	IO_L28P_5	AP30	
5	IO_L27N_5/VREF_5	AH24	
5	IO_L27P_5	AH25	
5	IO_L26N_5	AF22	
5	IO_L26P_5	AF23	
5	IO_L25N_5	AM27	
5	IO_L25P_5	AM26	
5	IO_L24N_5	AL27	
5	IO_L24P_5	AL26	
5	IO_L23N_5	AH26	
5	IO_L23P_5	AJ25	
5	IO_L22N_5	AN31	
5	IO_L22P_5	AN30	
5	IO_L21N_5/VREF_5	AK26	
5	IO_L21P_5	AK27	
5	IO_L20N_5	AG23	
5	IO_L20P_5	AF24	
5	IO_L19N_5	AM33	
5	IO_L19P_5	AN32	
5	IO_L06N_5	AJ27	
5	IO_L06P_5	AJ26	
5	IO_L05N_5/VRP_5	AE22	
5	IO_L05P_5/VRN_5	AE23	
5	IO_L04N_5	AM28	
5	IO_L04P_5/VREF_5	AM29	
5	IO_L03N_5/D4/ALT_VRP_5	AK28	
5	IO_L03P_5/D5/ALT_VRN_5	AL29	
5	IO_L02N_5/D6	AG24	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	AP33	
NA	GND	AP32	
NA	GND	AP27	
NA	GND	AP8	
NA	GND	AP3	
NA	GND	AP2	
NA	GND	AN34	
NA	GND	AN33	
NA	GND	AN20	
NA	GND	AN15	
NA	GND	AN2	
NA	GND	AN1	
NA	GND	AM34	
NA	GND	AM32	
NA	GND	AM25	
NA	GND	AM10	
NA	GND	AM3	
NA	GND	AM1	
NA	GND	AL31	
NA	GND	AL4	
NA	GND	AK30	
NA	GND	AK23	
NA	GND	AK12	
NA	GND	AK5	
NA	GND	AJ29	
NA	GND	AJ6	
NA	GND	AH28	
NA	GND	AH21	
NA	GND	AH14	
NA	GND	AH7	
NA	GND	AG34	
NA	GND	AG27	
NA	GND	AG8	
NA	GND	AG1	
NA	GND	AF19	
NA	GND	AF16	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L57P_2/VREF_2	P7		
2	IO_L58N_2	R3		
2	IO_L58P_2	P3		
2	IO_L59N_2	T10		
2	IO_L59P_2	U10		
2	IO_L60N_2	P4		
2	IO_L60P_2	N4		
2	IO_L67N_2	T6		
2	IO_L67P_2	R6		
2	IO_L68N_2	T9		
2	IO_L68P_2	U9		
2	IO_L69N_2	T5		
2	IO_L69P_2/VREF_2	R5		
2	IO_L70N_2	R1		
2	IO_L70P_2	P1		
2	IO_L71N_2	V12		
2	IO_L71P_2	W12		
2	IO_L72N_2	T4		
2	IO_L72P_2	R4		
2	IO_L73N_2	T2		
2	IO_L73P_2	R2		
2	IO_L74N_2	V11		
2	IO_L74P_2	W11		
2	IO_L75N_2	U7		
2	IO_L75P_2/VREF_2	T7		
2	IO_L76N_2	U3		
2	IO_L76P_2	T3		
2	IO_L77N_2	V10		
2	IO_L77P_2	W10		
2	IO_L78N_2	V6		
2	IO_L78P_2	U6		
2	IO_L79N_2	U1		
2	IO_L79P_2	T1		
2	IO_L80N_2	V9		
2	IO_L80P_2	W9		
2	IO_L81N_2	V5		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	D4		
NA	GND	C39		
NA	GND	C38		
NA	GND	C37		
NA	GND	C3		
NA	GND	C2		
NA	GND	C1		
NA	GND	B39		
NA	GND	B38		
NA	GND	B37		
NA	GND	B29		
NA	GND	B11		
NA	GND	B3		
NA	GND	B2		
NA	GND	B1		
NA	GND	A38		
NA	GND	A37		
NA	GND	A20		
NA	GND	A3		
NA	GND	A2		

Notes:

1. See [Table 4](#) for an explanation of the signals available on this pin.

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
6	IO_L67P_6	AB30	
6	IO_L67N_6	AA30	
6	IO_L68P_6	W26	
6	IO_L68N_6	V26	
6	IO_L69P_6	AB31	
6	IO_L69N_6/VREF_6	AA31	
6	IO_L70P_6	AA29	
6	IO_L70N_6	Y29	
6	IO_L71P_6	Y24	
6	IO_L71N_6	W24	
6	IO_L72P_6	V25	
6	IO_L72N_6	U25	
6	IO_L73P_6	Y28	
6	IO_L73N_6	W28	
6	IO_L74P_6	W23	
6	IO_L74N_6	V23	
6	IO_L75P_6	Y30	
6	IO_L75N_6/VREF_6	W30	
6	IO_L76P_6	Y31	
6	IO_L76N_6	W31	
6	IO_L77P_6	V27	
6	IO_L77N_6	U27	
6	IO_L78P_6	W29	
6	IO_L78N_6	U29	
6	IO_L91P_6	U23	
6	IO_L91N_6	T23	
6	IO_L92P_6	U26	
6	IO_L92N_6	T26	
6	IO_L93P_6	V28	
6	IO_L93N_6/VREF_6	U28	
6	IO_L94P_6	U24	
6	IO_L94N_6	T24	
6	IO_L95P_6	V30	
6	IO_L95N_6	U30	
6	IO_L96P_6	V31	
6	IO_L96N_6	U31	
7	IO_L96P_7	T27	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L53N_7	K30	
7	IO_L52P_7	L28	
7	IO_L52N_7	J28	
7	IO_L51P_7/VREF_7	M24	
7	IO_L51N_7	L24	
7	IO_L50P_7	L29	
7	IO_L50N_7	K29	
7	IO_L49P_7	M25	
7	IO_L49N_7	L25	
7	IO_L48P_7	L26	
7	IO_L48N_7	J26	
7	IO_L47P_7	J31	
7	IO_L47N_7	H31	
7	IO_L46P_7	J29	
7	IO_L46N_7	H29	
7	IO_L45P_7/VREF_7	M22	
7	IO_L45N_7	L22	
7	IO_L44P_7	J30	
7	IO_L44N_7	G30	
7	IO_L43P_7	K27	
7	IO_L43N_7	J27	
7	IO_L27P_7/VREF_7	L23	NC
7	IO_L27N_7	K23	NC
7	IO_L25P_7	G31	NC
7	IO_L25N_7	F31	NC
7	IO_L24P_7	F30	
7	IO_L24N_7	E30	
7	IO_L23P_7	K25	
7	IO_L23N_7	J25	
7	IO_L22P_7	H28	
7	IO_L22N_7	G28	
7	IO_L21P_7/VREF_7	H27	
7	IO_L21N_7	G27	
7	IO_L20P_7	K24	
7	IO_L20N_7	J24	
7	IO_L19P_7	E31	
7	IO_L19N_7	D31	
7	IO_L06P_7	F28	

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Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- [Virtex-II Platform FPGAs: Introduction and Overview \(Module 1\)](#)
- [Virtex-II Platform FPGAs: Functional Description \(Module 2\)](#)
- [Virtex-II Platform FPGAs: DC and Switching Characteristics \(Module 3\)](#)
- [Virtex-II Platform FPGAs: Pinout Information \(Module 4\)](#)